Effect of Interface on the Structure and Ferro-electric Property of Y-doped HfO₂ Thin Films Prepared by Reactive Magnetron Co-Sputtering

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10 nm-thick ferroelectric HfO₂films with 1.5 mol%₀yttrium-doping were fabricated by mid-frequency reactivemagnetron co-sputtering deposition on bare Si and underlying ultrathin Hfbuffer layer. Yttrium was incorporated into the HfO₂ films bysimultaneously sputtering from Y and Hf metal targets under oxygen/argonmixture atmosphere. The presence of a non-centrosymmetric orthorhombic phaseresponsible for ferroelectricity properties in yttrium-doped HfO₂ (Y:HfO₂)films after annealing treatment was established by high-resolution transmissionelectron microscopy and X-ray diffraction. The interfacial oxide layerstructure and electrical properties of Y:HfO₂films with and without Hf buffer layer were investigated. Effects ofinterfacial layer on the ferroelectric characteristics were studied accordingto the theory calculation and analysis of experiments. As an initial oxidationprotective layer, the ultra-thin Hf (~1nm) layer covers the silicon surface and prevents the initial

silicon oxidation during the deposition and post-annealing process. A remnant polarization P_r of up to14 μ C/cm² was obtained in Y:HfO₂ with Hf buffer layer. It was shown that the presence of Hf buffer layer not only improve the permittivity but also essential for the ferroelectricy of Y-doped HfO₂ thin films deposited by reactive magnetron sputtering.

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